

SN74LVC1G04-EP

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SCES691A-MARCH 2007-REVISED OCTOBER 2008

SINGLE INVERTER GATE

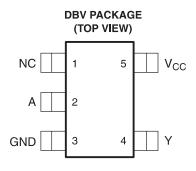
FEATURES

- Supports 5-V V_{CC} Operation
- Inputs Accept Voltages to 5.5 V
- Max t_{nd} of 3.3 ns at 3.3 V
- Low Power Consumption, 10-µA Max I_{CC}
- ±24-mA Output Drive at 3.3 V
- Ioff Supports Partial-Power-Down Mode Operation
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- **ESD Protection Exceeds JESD 22**
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)

SUPPORTS DEFENSE, AEROSPACE, AND MEDICAL APPLICATIONS

- **Controlled Baseline**
- **One Assembly/Test Site**
- **One Fabrication Site**
- Available in Military (–55°C/125°C) **Temperature Range**⁽¹⁾
- **Extended Product Life Cycle**
- **Extended Product-Change Notification**
- **Product Traceability**

(1) Custom temperature ranges available



NC - No internal connection

DESCRIPTION/ORDERING INFORMATION

This single inverter gate is designed for 1.65-V to 5.5-V V_{CC} operation.

The SN74LVC1G04 performs the Boolean function $Y = \overline{A}$.

NanoStar[™] and NanoFree[™] package technology is a major breakthrough in IC packaging concepts, using the die as the package.

This device is fully specified for partial-power-down applications using Ioff. The Ioff circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.



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TEXAS INSTRUMENTS

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ORDERING INFORMATION

| T _A | PACKAGE ⁽¹⁾ | | ORDERABLE PART NUMBER | TOP-SIDE MARKING ⁽²⁾ |
|----------------|------------------------|--------------|-----------------------|---------------------------------|
| –55°C to 125°C | SOT (SOT-23) – DBV | Reel of 3000 | SN74LVC1G04MDBVREP | SBKM |

(1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI website at www.ti.com.

(2) DBV: The actual top-side marking has one additional character that designates the assembly/test site.

FUNCTION TABLE

| INPUT A | OUTPUT Y |
|------------|-------------|
| Н | L |
| L | н |

LOGIC DIAGRAM (POSITIVE LOGIC)



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Absolute Maximum Ratings⁽¹⁾

over operating free-air temperature range (unless otherwise noted)

| | | | MIN | MAX | UNIT |
|------------------|--|-------------------------------------|------|-----------------------|------|
| V _{CC} | Supply voltage range | | -0.5 | 6.5 | V |
| VI | Input voltage range | -0.5 | 6.5 | V | |
| Vo | Voltage range applied to any output in the | -0.5 | 6.5 | V | |
| Vo | Voltage range applied to any output in the | high or low state ⁽²⁾⁽³⁾ | -0.5 | V _{CC} + 0.5 | V |
| I _{IK} | Input clamp current | V _I < 0 | | -50 | mA |
| I _{OK} | Output clamp current | V _O < 0 | | -50 | mA |
| I _O | Continuous output current | | | ±50 | mA |
| | Continuous current through V_{CC} or GND | | | ±100 | mA |
| θ_{JA} | Package thermal impedance ⁽⁴⁾ | | | 206 | °C/W |
| T _{stg} | Storage temperature range | | -65 | 150 | °C |

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.

(3) The value of V_{CC} is provided in the recommended operating conditions table.

(4) The package thermal impedance is calculated in accordance with JESD 51-7.

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Recommended Operating Conditions⁽¹⁾

| | | | MIN | MAX | UNIT | |
|-----------------|------------------------------------|--|----------------------|----------------------|------|--|
| \ / | Supply voltage | Operating | 1.65 | 5.5 | v | |
| V _{CC} | Supply voltage | Data retention only | 1.5 | | v | |
| | | V_{CC} = 1.65 V to 1.95 V | $0.65 \times V_{CC}$ | | | |
| V | High-level input voltage | V_{CC} = 2.3 V to 2.7 V | 1.7 | | v | |
| VIH | High-level liput voltage | V_{CC} = 3 V to 3.6 V | 2 | | v | |
| | | V_{CC} = 4.5 V to 5.5 V | $0.7 \times V_{CC}$ | | | |
| | | V_{CC} = 1.65 V to 1.95 V | | $0.35 \times V_{CC}$ | | |
| V | Low lovel input veltage | V_{CC} = 2.3 V to 2.7 V | | 0.7 | - | |
| V _{IL} | Low-level input voltage | V_{CC} = 3 V to 3.6 V | | 0.8 | v | |
| | | V_{CC} = 4.5 V to 5.5 V | | $0.3 \times V_{CC}$ | | |
| VI | Input voltage | | 0 | 5.5 | V | |
| Vo | Output voltage | | 0 | V _{CC} | V | |
| | | V _{CC} = 1.65 V | | -4 | | |
| | | $V_{CC} = 2.3 V$ | | -8 | | |
| I _{OH} | High-level output current | $V_{CC} = 3 V$ | | -16 | mA | |
| | | V _{CC} = 3 V | | -24 | | |
| | | $V_{CC} = 4.5 V$ | | -32 | | |
| | | V _{CC} = 1.65 V | | 4 | | |
| | | $V_{CC} = 2.3 V$ | | 8 | | |
| I _{OL} | Low-level output current | $V_{CC} = 3 V$ | | 16 | mA | |
| | | V _{CC} = 5 V | | 24 | | |
| | | $V_{CC} = 4.5 V$ | | 32 | 1 | |
| | | V_{CC} = 1.8 V ± 0.15 V, 2.5 V ± 0.2 V | | 20 | | |
| Δt/Δv | Input transition rise or fall rate | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ | | 10 | ns/V | |
| | | $V_{CC} = 5 \text{ V} \pm 0.5 \text{ V}$ | | 5 | | |
| T _A | Operating free-air temperature | · · · · · · · · · · · · · · · · · · · | -55 | 125 | °C | |

(1) All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

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Electrical Characteristics

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | V _{cc} | MIN TYP | ⁽¹⁾ MAX | UNIT | | |
|------------------|---|-----------------|-----------------------|--------------------|------|--|--|
| | I _{OH} = -100 μA | 3.6V | V _{CC} - 0.1 | | | | |
| | $I_{OH} = -4 \text{ mA}$ | 1.65 V | 1.2 | | | | |
| | I _{OH} = -8 mA | 2.3 V | 1.9 | | V | | |
| V _{OH} | I _{OH} = -16 mA | 2.14 | 2.4 | | V | | |
| | I _{OH} = -24 mA | 3 V | 2.3 | | | | |
| | I _{OH} = -32 mA | 4.5 V | 3.8 | | | | |
| | I _{OL} = 100 μA | 3.6 V to 5.5 V | | | | | |
| | I _{OL} = 4 mA | 1.65 V | | 0.45 | | | |
| | I _{OL} = 8 mA | 2.3 V | | V | | | |
| V _{OL} | I _{OL} = 16 mA | 2.14 | | 0.4 | V | | |
| | $I_{OL} = 24 \text{ mA}$ | - 3 V | | | | | |
| | I _{OL} = 32 mA | 4.5 V | | 0.55 | | | |
| II A input | $V_{I} = 5.5 \text{ V or GND}$ | 0 to 5.5 V | | ±5 | μA | | |
| l _{off} | V_{I} or V_{O} = 5.5 V | 0 | | ±10 | μA | | |
| I _{CC} | $V_{I} = 5.5 \text{ V or GND}$ $I_{O} = 0$ | 1.65 V to 5.5 V | | 10 | μA | | |
| ΔI _{CC} | One input at $V_{CC} - 0.6 V$, Other inputs at V_{CC} or GND | 3 V to 5.5 V | | 500 | μA | | |
| CI | $V_{I} = V_{CC} \text{ or } GND$ | 3.3 V | 3 | .5 | pF | | |

(1) All typical values are at $V_{CC} = 3.3$ V, $T_A = 25^{\circ}C$.

Switching Characteristics

over recommended operating free-air temperature range, $C_L = 30 \text{ pF}$ or 50 pF (unless otherwise noted) (see Figure 2)

| PARAMETER | RAMETER FROM (INPUT) | TO (OUTPUT) | V _{CC} = ± 0.7 | 1.8 V 15 V | ~~ | V _{CC} = 2.5 V ± 0.2 V | | V _{CC} = 3.3 V ± 0.3 V | | V _{CC} = 5 V ± 0.5 V | |
|-----------------|-------------------------|----------------|----------------------------|---------------|-----|------------------------------------|-----|------------------------------------|-----|----------------------------------|------|
| | (INFOT) | (001701) | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | UNIT |
| t _{pd} | А | Y | 3 | 13.9 | 1.4 | 8.0 | 1 | 5.7 | 1 | 4.5 | ns |

Operating Characteristics

 $T_A = 25^{\circ}C$

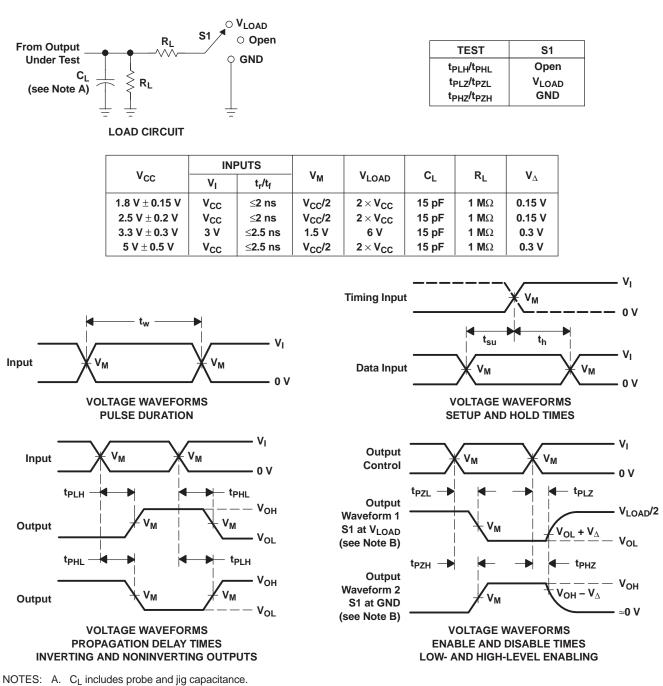
| | PARAMETER | TEST CONDITIONS | V _{CC} = 1.8 V TYP | V _{CC} = 2.5 V TYP | V _{CC} = 3.3 V TYP | V _{CC} = 5 V | UNIT TYP |
|----------|-------------------------------|--------------------|--------------------------------|--------------------------------|--------------------------------|-----------------------|-------------|
| C_{pd} | Power dissipation capacitance | f = 10 MHz | 16 | 18 | 18 | 20 | pF |

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PARAMETER MEASUREMENT INFORMATION

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control. C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z₀ = 50 Ω .
- D. The outputs are measured one at a time, with one transition per measurement.
- E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
- F. t_{PZL} and t_{PZH} are the same as t_{en}.
- G. t_{PLH} and t_{PHL} are the same as t_{pd} .
- H. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms

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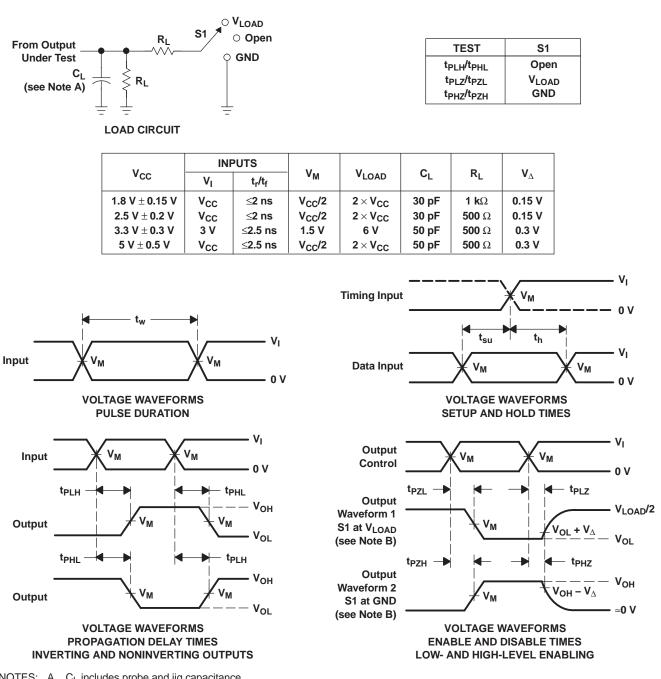
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PARAMETER MEASUREMENT INFORMATION

NOTES: A. CL includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control. C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_O = 50 Ω .
- D. The outputs are measured one at a time, with one transition per measurement.
- E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
- F. t_{PZL} and t_{PZH} are the same as t_{en}.
- G. t_{PLH} and t_{PHL} are the same as t_{pd} .
- H. All parameters and waveforms are not applicable to all devices.

Figure 2. Load Circuit and Voltage Waveforms



10-Dec-2020

PACKAGING INFORMATION

| Orderable Device | Status (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan (2) | Lead finish/ Ball material (6) | MSL Peak Temp (3) | Op Temp (°C) | Device Marking (4/5) | Samples |
|--------------------|---------------|--------------|--------------------|------|----------------|-----------------|--------------------------------------|----------------------|--------------|-------------------------|---------|
| SN74LVC1G04MDBVREP | ACTIVE | SOT-23 | DBV | 5 | 3000 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -55 to 125 | SBKM | Samples |
| V62/07625-01XE | ACTIVE | SOT-23 | DBV | 5 | 3000 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -55 to 125 | SBKM | Samples |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <= 1000ppm threshold. Antimony trioxide based flame retardants must also meet the <= 1000ppm threshold requirement.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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PACKAGE OPTION ADDENDUM

10-Dec-2020

OTHER QUALIFIED VERSIONS OF SN74LVC1G04-EP :

• Catalog: SN74LVC1G04

• Automotive: SN74LVC1G04-Q1

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Automotive Q100 devices qualified for high-reliability automotive applications targeting zero defects

PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



| *All dimensions are nomina |
|----------------------------|
|----------------------------|

| Device | • | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------------|--------|--------------------|---|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| SN74LVC1G04MDBVREP | SOT-23 | DBV | 5 | 3000 | 180.0 | 8.4 | 3.23 | 3.17 | 1.37 | 4.0 | 8.0 | Q3 |

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PACKAGE MATERIALS INFORMATION

24-Apr-2020



*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|--------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74LVC1G04MDBVREP | SOT-23 | DBV | 5 | 3000 | 202.0 | 201.0 | 28.0 |

DBV0005A



PACKAGE OUTLINE

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
 This drawing is subject to change without notice.
 Reference JEDEC MO-178.

- 4. Body dimensions do not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.25 mm per side.
- 5. Support pin may differ or may not be present.



DBV0005A

EXAMPLE BOARD LAYOUT

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

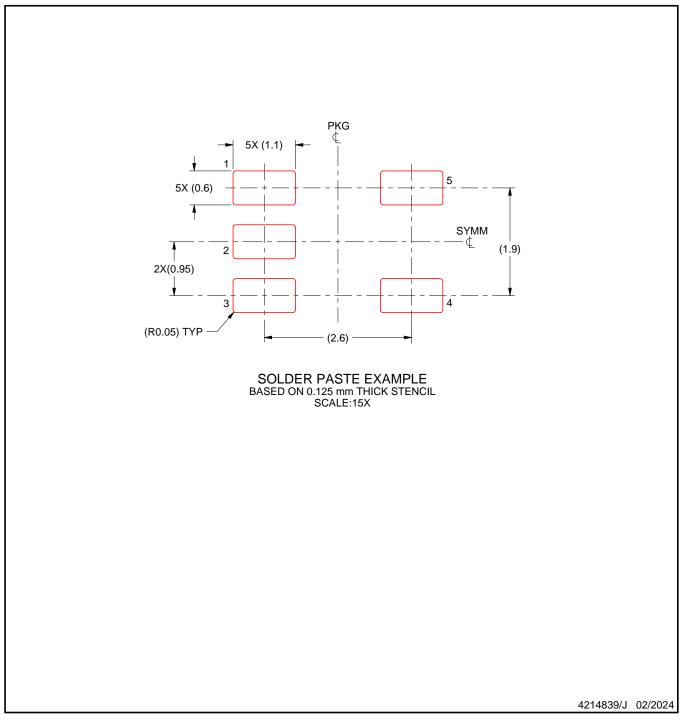


DBV0005A

EXAMPLE STENCIL DESIGN

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

9. Board assembly site may have different recommendations for stencil design.



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